Specifications

Eaton 281404

Eaton Moeller® series CI Insulated enclosure, IP65_x, +operating membrane, for PKZ01

PRODUCT NAME Eaton Moeller® series CI Insulated enclosure	
CATALOG NUMBER 281404	
PRODUCT LENGTH/DEPTH 116.5 mm	
PRODUCT HEIGHT 158 mm	
PRODUCT WIDTH 80 mm	
PRODUCT WEIGHT 0.25 kg	
CERTIFICATIONS CE	
CATALOG NOTES Not suitable for PKZM0 PI / PKZM0SPI32	
EAN 4015082814045	
MODEL CODE CI-PKZ01-G	



Product specifications	S
USED WITH	PKZ series
10.10 TEMPERATURE RISE	The panel builder is responsible for the temperature rise calculation. Eaton will provide heat dissipation data for the devices.
10.11 SHORT-CIRCUIT RATING	Is the panel builder's responsibility. The specifications for the switchgear must be observed.
10.12 ELECTROMAGNETIC COMPATIBILITY	Is the panel builder's responsibility. The specifications for the switchgear must be observed.
10.13 MECHANICAL FUNCTION	The device meets the requirements, provided the information in the instruction leaflet (IL) is observed.
10.2.2 CORROSION RESISTANCE	Meets the product standard's requirements.
10.2.3.1 VERIFICATION OF THERMAL STABILITY OF ENCLOSURES	Meets the product standard's requirements.
10.2.3.2 VERIFICATION OF RESISTANCE OF INSULATING MATERIALS TO NORMAL HEAT	Meets the product standard's requirements.
10.2.3.3 RESIST. OF INSUL. MAT. TO ABNORMAL HEAT/FIRE BY INTERNAL ELECT. EFFECTS	Meets the product standard's requirements.
10.2.4 RESISTANCE TO ULTRA-VIOLET (UV) RADIATION	Please enquire
10.2.5 LIFTING	Does not apply, since the entire switchgear needs to be evaluated.
10.2.6 MECHANICAL IMPACT	Does not apply, since the entire switchgear needs to be evaluated.
10.2.7 INSCRIPTIONS	Meets the product standard's requirements.
10.3 DEGREE OF PROTECTION OF	Does not apply, since the entire switchgear needs to

Resources	
BROCHURES	Brochure - CI-K small enclosures
DECLARATIONS OF CONFORMITY	CE CIPKZ Surface mounted enclosures and accessories PKZ UKCA CIPKZ Surface mounted enclosures and accessories PKZ
DRAWINGS	eaton-small-enclosures- enclosure-ci-insulated- enclosure-dimensions.eps eaton-small-enclosures- enclosure-ci-insulated- enclosure-3d-drawing- 002.eps
ECAD MODEL	ETN.CI-PKZ01-G
INSTALLATION INSTRUCTIONS	IL03407018Z2021 10.pdf
MCAD MODEL	DA-CS-ci_pkz01_g DA-CD-ci_pkz01_g
WIRING DIAGRAMS	eaton-manual-motor- starters-transformer- pkzm0-wiring-diagram.eps

40001101:	
ASSEMBLIES	be evaluated.
10.4 CLEARANCES AND CREEPAGE DISTANCES	Meets the product standard's requirements.
10.5 PROTECTION AGAINST ELECTRIC SHOCK	Does not apply, since the entire switchgear needs to be evaluated.
10.6 INCORPORATION OF SWITCHING DEVICES AND COMPONENTS	Does not apply, since the entire switchgear needs to be evaluated.
10.7 INTERNAL ELECTRICAL CIRCUITS AND CONNECTIONS	Is the panel builder's responsibility.
10.8 CONNECTIONS FOR EXTERNAL CONDUCTORS	Is the panel builder's responsibility.
10.9.2 POWER- FREQUENCY ELECTRIC STRENGTH	Is the panel builder's responsibility.
10.9.3 IMPULSE WITHSTAND VOLTAGE	ls the panel builder's responsibility.
10.9.4 TESTING OF ENCLOSURES MADE OF INSULATING MATERIAL	ls the panel builder's responsibility.
FITTED WITH:	PE(N) terminal
	Operating membrane
ENCLOSURE MATERIAL	Operating membrane Plastic
ENCLOSURE MATERIAL AMBIENT OPERATING	Plastic
ENCLOSURE MATERIAL AMBIENT OPERATING TEMPERATURE - MAX AMBIENT OPERATING	Plastic 70 °C
ENCLOSURE MATERIAL AMBIENT OPERATING TEMPERATURE - MAX AMBIENT OPERATING TEMPERATURE - MIN EQUIPMENT HEAT DISSIPATION, CURRENT-	Plastic 70 °C -25 °C
ENCLOSURE MATERIAL AMBIENT OPERATING TEMPERATURE - MAX AMBIENT OPERATING TEMPERATURE - MIN EQUIPMENT HEAT DISSIPATION, CURRENT- DEPENDENT PVID HEAT DISSIPATION	Plastic 70 °C -25 °C 0 W
ENCLOSURE MATERIAL AMBIENT OPERATING TEMPERATURE - MAX AMBIENT OPERATING TEMPERATURE - MIN EQUIPMENT HEAT DISSIPATION, CURRENT- DEPENDENT PVID HEAT DISSIPATION CAPACITY PDISS HEAT DISSIPATION PER POLE, CURRENT-	Plastic 70 °C -25 °C 0 W 10 W
ENCLOSURE MATERIAL AMBIENT OPERATING TEMPERATURE - MAX AMBIENT OPERATING TEMPERATURE - MIN EQUIPMENT HEAT DISSIPATION, CURRENT- DEPENDENT PVID HEAT DISSIPATION CAPACITY PDISS HEAT DISSIPATION PER POLE, CURRENT- DEPENDENT PVID RATED OPERATIONAL CURRENT FOR SPECIFIED	Plastic 70 °C -25 °C 0 W 10 W
ENCLOSURE MATERIAL AMBIENT OPERATING TEMPERATURE - MAX AMBIENT OPERATING TEMPERATURE - MIN EQUIPMENT HEAT DISSIPATION, CURRENT- DEPENDENT PVID HEAT DISSIPATION CAPACITY PDISS HEAT DISSIPATION PER POLE, CURRENT- DEPENDENT PVID RATED OPERATIONAL CURRENT FOR SPECIFIED HEAT DISSIPATION (IN) STATIC HEAT DISSIPATION, NON- CURRENT-DEPENDENT	Plastic 70 °C -25 °C 0 W 10 W 0 A
ENCLOSURE MATERIAL AMBIENT OPERATING TEMPERATURE - MAX AMBIENT OPERATING TEMPERATURE - MIN EQUIPMENT HEAT DISSIPATION, CURRENT- DEPENDENT PVID HEAT DISSIPATION CAPACITY PDISS HEAT DISSIPATION PER POLE, CURRENT- DEPENDENT PVID RATED OPERATIONAL CURRENT FOR SPECIFIED HEAT DISSIPATION (IN) STATIC HEAT DISSIPATION, NON- CURRENT-DEPENDENT PVS	Plastic 70 °C -25 °C 0 W 10 W 0 A

Hard mirror with cable entry knockouts (can be

cut out)

2 x M25 (cable entry knockout with thread at

the bottom)

2 x M25 (cable entry knockout with thread at

the top)

2 x M20 (cable entry knockouts at the rear)

PROJECT NAME:

KNOCKOUTS

PROJECT NUMBER:

PREPARED BY:

DATE:



Eaton Corporation plc

Eaton House 30 Pembroke Road Dublin 4, Ireland Eaton.com

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